

Noise characterization of patch antenna THz photodetectors

D. Palaferri, Y. Todorov, D. Gacemi, S Barbieri, L. Li, A. Davies, E. H

Linfield, C. Sirtori

▶ To cite this version:

D. Palaferri, Y. Todorov, D. Gacemi, S Barbieri, L. Li, et al.. Noise characterization of patch antenna THz photodetectors. Applied Physics Letters, 2018, 113 (16), pp.161105. 10.1063/1.5051580 . hal-02403210

HAL Id: hal-02403210 https://hal.science/hal-02403210

Submitted on 27 May 2022

HAL is a multi-disciplinary open access archive for the deposit and dissemination of scientific research documents, whether they are published or not. The documents may come from teaching and research institutions in France or abroad, or from public or private research centers. L'archive ouverte pluridisciplinaire **HAL**, est destinée au dépôt et à la diffusion de documents scientifiques de niveau recherche, publiés ou non, émanant des établissements d'enseignement et de recherche français ou étrangers, des laboratoires publics ou privés.

Noise characterization of patch antenna THz photodetectors

Cite as: Appl. Phys. Lett. **113**, 161105 (2018); https://doi.org/10.1063/1.5051580 Submitted: 10 August 2018 • Accepted: 30 September 2018 • Published Online: 16 October 2018

🔟 D. Palaferri, Y. Todorov, D. Gacemi, et al.

ARTICLES YOU MAY BE INTERESTED IN

Patch antenna terahertz photodetectors Applied Physics Letters **106**, 161102 (2015); https://doi.org/10.1063/1.4918983

Antenna-coupled microcavities for enhanced infrared photo-detection Applied Physics Letters **104**, 031113 (2014); https://doi.org/10.1063/1.4862750

High temperature metamaterial terahertz quantum detector Applied Physics Letters **117**, 251102 (2020); https://doi.org/10.1063/5.0033367



Lock-in Amplifiers up to 600 MHz





Appl. Phys. Lett. **113**, 161105 (2018); https://doi.org/10.1063/1.5051580 © 2018 Author(s).



Noise characterization of patch antenna THz photodetectors

D. Palaferri,^{1,2,a)} Y. Todorov,¹ D. Gacemi,¹ S. Barbieri,^{1,b)} L. H. Li,³ A. G. Davies,³ E. H. Linfield,³ and C. Sirtori^{1,a)}

¹Laboratoire Matériaux et Phénomènes Quantiques, Université Paris Diderot, Sorbonne Paris Cité,

CNRS-UMS 7162, 75013 Paris, France

²Department of Electrical and Computer Engineering, The University of Texas at Austin, Austin, Texas 78758, USA

³School of Electronic and Electrical Engineering, University of Leeds, Leeds LS2 9JT, United Kingdom

(Received 10 August 2018; accepted 30 September 2018; published online 16 October 2018)

Current noise fluctuations have been investigated in terahertz (THz) quantum well photodetectors embedded in antenna-coupled photonic architectures and compared with standard substrate-coupled mesa detectors. The noise measurements give a value of the photoconductive gain that is in excellent agreement with that extracted from previous responsivity calibrations. Moreover, our results confirm that the noise equivalent power (NEP) of the antenna-coupled devices is of the order of 0.2 pW/Hz^{0.5}. This low NEP value and the wide band frequency response (~GHz) of the detectors are ideal figures for the development of heterodyne receivers that are, at present, a valuable technological solution to overcome the current limitation of THz sensors. *Published by AIP Publishing*. https://doi.org/10.1063/1.5051580

Quantum well infrared photo-detectors (QWIPs) have been demonstrated over the last 30 years to be fast and sensitive receivers in the mid- and far-infrared frequency ranges.^{1,2} These optoelectronic devices are based on III-V semiconductor heterostructures and most typically on GaAs/ AlGaAs quantum wells (QWs). Their detection wavelength is set primarily by the QW width, as light absorption occurs through electronic transitions between two-dimensional QW states in the conduction band, called inter-subband (ISB) transitions. Device optimization is controlled through judicious choices of QW barrier thickness and Si doping³ to minimize the inter-well tunneling current and the thermally induced dark current, respectively. In 2005,⁴ H.C. Liu and co-authors reported QWIP devices operating at terahertz (THz) frequencies (1-10 THz) by employing low doping levels ($\sim 1 \times 10^{10}$ cm⁻²) and low Al contents in the barriers (1%-5%). These detectors have received special attention owing to their high responsivity $(\sim A/W)^{4-9}$ and wide band frequency response (\sim GHz).^{9,10} The coexistence of high sensitivity and high speed¹¹ is a unique property of QWIPs when compared to state-of-the-art THz receivers. Indeed, commercially available THz detectors with high detectivity (D*) such as hot-electron bolometers (D* $\sim 10^{10}$ -10¹¹ cm Hz^{0.5}), Golay cells, and DTGS crystals (D* $\sim 10^9$ – 10^{10} cm Hz^{0.5}) are limited by their low response frequency (from few Hz up to tens of kHz).¹² An ultra-fast THz detector would be beneficial in many applications including broad wireless communication,¹³ the study of charge carrier dynamics in condensed matter,¹⁴ terahertz frequency imaging,¹⁵ frequency comb multiheterodyne spectroscopy,¹⁶ and ultra-fast laser research.¹⁷

Recently, we have demonstrated a double metal patchantenna array architecture^{18,19} that significantly improves the

responsivity and the thermal performances of a 5.4 THz QWIP (Ref. 8) with respect to the traditional 45° facet substrate-coupled geometry.^{1,4} When using a $7 \,\mu m$ patch antenna-coupled microcavity device (the cavity size that gave the best performance), we reported an noise equivalent power (NEP) of 0.18 pW/Hz^{0.5} and a background-limited detectivity D_{BL}^* of 1.7×10^{11} cm Hz^{0.5}/W at T = 4 K and 0.1 V. In the original work of H.C. Liu, considering the measured responsivity and background current and assuming a similar photoconductive gain, the mesa device has a detectivity of $D_{BL}^* = 3.5 \times 10^{10}$ cm Hz^{0.5}/W. Our enhancement in device performance is a consequence of the increased photonic confinement, the improved light coupling, and the strongly reduced dark current.²⁰ With the same photonic architecture, similar results have also been recently observed for a mid-infrared OWIP at $\lambda = 9 \,\mu \text{m.}^{21}$ However, a reliable calibration of performance requires noise current measurements in order to confirm the noise-equivalent-power and the detectivity values estimated from the responsivity and the dc background current. Interestingly, noise current fluctuations have been extensively investigated in mid-infrared QWIPs,^{22–26} but never for THz detectors.

Here, we report the current noise measurements for THz frequency ISB photodetectors, using the 5.4 THz QWIP structure reported in Ref. 8 processed both into a mesa structure with a 45° facet coupling and into a patch-antenna array. The resonant patch array devices (of size 7 μ m) are found to have an NEP in the range of 0.14–0.22 pW/Hz^{0.5}, whilst those in the mesa geometry are found to have an NEP in the range of 0.6–1.3 pW/Hz^{0.5}. These values validate the ~five-fold performance improvement previously obtained using the values of background current and responsivity.⁸

Three devices were used for the noise current investigation: a $400 \times 400 \,\mu\text{m}^2$ square mesa and two $300 \times 300 \,\mu\text{m}^2$ patch-antenna arrays. The patch antenna devices can be categorised by their total number of patches N_{array} and the array unit cell $\Sigma = (s + a)^2$, where s is the cavity size and a is the

^{a)}Authors to whom correspondence should be addressed: dpalaferri@utexas.edu and carlo.sirtori@univ-paris-diderot.fr

^{b)}Present address: Institut d'Electronique de Microélectronique et de Nanotechnologie (IEMN), CNRS UMR 8520 Université de Lille 1, Avenue Poincaré B.P. 60069, 59652 Villeneuve d'Ascq, France.

distance between two neighboring patches. The parameters of the first resonant array device are $N_{array} = 196$ and Σ = 484 μ m² (s = 7 μ m and a = 15 μ m), and those of the second array device are $N_{array} = 256$ and $\Sigma = 361 \,\mu\text{m}^2$ (s = 9 μm and $a = 10 \,\mu\text{m}$). The top-left panel of Fig. 1 shows an SEM image of the device illustrating the difference between the physical area $\sigma = s^2$ and the array unit cell Σ ; the bottom-left panel depicts the biased two-level QW structure of the detector active region (E_1 and E_2 are the two subband energy levels). The details on the microfabrication and the MBE growth structure are given in Ref. 8. A sketch of the experimental arrangement is shown on the right of Fig. 1: the THz QWIP devices are fed by a dc source and connected to a low-noise trans-impedance amplifier, femto DLPCA-200 (with a variable gain resistance of $R_G = 10^3 - 10^{11} \Omega$). The amplified ac noise current is measured using a signal analyzer, HP 89441A. Each measurement comprises the average of 100 acquisitions over the spectral range of $10^2 - 10^6$ Hz. The THz QWIPs are cryogenically cooled to liquid-He temperatures, and the detector chip is covered with a cryo-shield at 4K that is completely closed for dark current noise measurements and open, with a field of view $FOV = 60^{\circ}$, for background current noise measurements (as depicted in Fig. 1). The noise current spectral density (A/Hz^{0.5}), measured by the signal analyzer, includes noise contributions from the QWIP device, the dc source, and the transimpedance amplifier. By separating these noise components, as explained in the supplementary material, it is possible to analyze the noise current of the THz detectors.

Figure 2 shows noise current spectral density measurements obtained by sweeping the voltage and temperature of the QWIP devices. Figures 2(a) and 2(b) show the noise current spectral density for the 7 μ m and 9 μ m cavity arrays, respectively, exposed to background radiation. As expected, the current noise increases upon increasing the applied voltage. We can identify three regions: a low frequency noise generated by external vibrations (100 Hz–1 kHz), a plateau revealing the generation-recombination noise of the QWIP (1 kHz–10 or 100 kHz), and the cut-off of the amplifier (100 kHz–1 MHz; the cutoff frequencies are $f_c = 500$ kHz and $f_c = 400$ kHz, for gain resistances $R_G = 10^6 \Omega$ and R_G $= 10^7 \Omega$, respectively, according to the amplifier datasheet²⁷). We note that ISB detectors do not typically show 1/*f* noise owing to the high quality of III-V materials and the



FIG. 1. Electronic arrangement for noise current measurements. The upper left panel shows a scanning electron microscopy image of the $9 \,\mu$ m cavity detector, whilst the lower scheme shows a two subband quantum well, together with the main sources of current.



FIG. 2. Current noise spectral density measurements for THz QWIPs under background exposure. The background current noise for the (a) 7 μ m and (b) 9 μ m array devices at T = 4 K is shown as a function of applied voltage, and (c) the background current noise for the 7 μ m array device is shown as a function of temperature at V = 50 mV. The Resistance amplifier is 10⁶ and 10⁷ Ω for the 7 μ m cavity array (a) and (c) and 10⁶ Ω for the 9 μ m (b). The inset in (c) illustrates the dc current-voltage characteristics of the 7 μ m array device, measured at the same temperature of the acquired noise spectra. (d) Comparison between measured current noise for the 7 μ m cavity array QWIP at 10 kHz and the estimated total background noise (continuous green line). The dashed orange and black lines show the background and dark current contributions, respectively. The dotted orange line represents the thermal noise contribution.

low number of carriers involved.²⁸ Above 10 kHz for the 7 μ m patch detector and above 40 kHz for the 9 μ m patch detector, we notice that the noise current increases as a function of the frequency: this effect has been previously reported in the literature²⁹ and can be directly related to the capacitance (of a few tens of pF) of the coaxial cable, $C_{\rm BNC}$, that connects the detector to the trans-impedance amplifier (see supplementary material). The narrow peaks occurring above 100 kHz [mainly in Figs. 2(a) and 2(c)] originate from an external noise signal interfering with our electronic arrangement. Similar background current noise measurements have been acquired for the mesa device and are included in the supplementary material, together with the dark current noise measurements for the 9 μ m cavity array.

Figure 2(c) illustrates the background current noise for the 7 μ m cavity array device at a constant bias of V_{QWIP} = 50 mV from T_{QWIP} = 4 K up to T_{QWIP} = 50 K. These temperature measurements have been acquired by employing different amplifier gains. The inset shows the dc background current I_{bg}(T) = I_{photo} + I_{dark}(T), where I_{photo} is the photocurrent generated by the 300 K background and I_{dark}(T) is the thermally activated dark current that increases exponentially with temperatures. This set of I_{bg} curves was measured at the same temperatures as the noise curves. At low temperatures, the I-V curves show the step-like dependency on the voltage due to an ISB impact ionization effect,³⁰ typically observed in THz QWIPs.^{8,30} Following the theory of classic photoconductors,^{2,3} the noise current spectral density

of THz QWIPs can be defined to be $i_n = (S_{GR} + S_T)^{0.5}$ with two distinct contributions: $S_{GR} = 4eg(I_{photo} + I_{dark})$ is the generation-recombination power spectral density (PSD) noise quantifying the electric charge fluctuation caused by random photogeneration and/or electronic transport dominated by scattering (g is the photoconductive gain); S_T $= 4k_B T_{OWIP}/R_{OWIP}$ is the Johnson-Nyquist noise, generated by the thermal fluctuations of charge carriers inside the QWIP active region ($k_{\rm B}$ is the Boltzmann constant and $R_{\rm OWIP}$ $= dV_{OWIP}/dI$ is the photodetector differential resistance). Regarding the generation-recombination noise PSD, several models have been reported for mid-infrared QWIPs²²⁻²⁶ that mainly depend on the estimated value of the electron capture probability, p_c , in the well. As it will be demonstrated in the following analysis, THz QWIPs show $p_c \ll 1$, confirming the H.C. Liu model.^{23,25}

Figure 2(d) illustrates the current noise for the 7 μ m array device from background radiation (open symbols), extracted at 10 kHz as shown in Fig. 2(c). The green continuous line represents the total current noise i_n : the generationrecombination term, S_{GR}, is estimated from the dc current [inset of Fig. 3(c)] and the gain from the responsivity calibration of Ref. 8; the Johnson-Nyquist term S_T is obtained from the dc differential resistance of the device. The red dotted line and the black dashed lines show the separated contributions of the thermal noise current $i_{n,T} = S_T^{10.5}$ and the dark current noise $i_{n,d} = (4egI_{dark})^{0.5}$, respectively: in the latter case, the dark current is written as $I_{dark} = I_0 exp(-E_a/k_BT)$, where I_0 is a constant and $E_a = 16.5 \text{ meV}$ is the activation energy obtained by fitting dark current curves of several THz QWIP devices.³¹ The orange dotted line indicates the background current noise $i_{n,ph} = (i_n^2 - i_{n,d}^2 - i_{n,T})^{0.5}$. The crossing of this curve with the dark current noise sets the backgroundlimited temperature, which corresponds to $T_{BLIP} = 21 \text{ K}^8$ for this device. We notice that the background noise $i_{n,ph}$ increases as a function of temperature: this phenomenon, still



FIG. 3. Photoconductive gain of the THz QWIPs. The continuous line shows the data from Ref. 8 obtained from the responsivity; the circular, square, and triangular dots correspond to the gain values obtained from the noise measurements of the mesa, 9 μ m, and 7 μ m array devices, respectively. The dot colors correspond to specific amplifier gain values: pink = $10^5 \Omega$, green = $10^6 \Omega$, red = $10^7 \Omega$, and blue = $10^8 \Omega$. The dark yellow dashed line represents the electron capture probability in the QWs.

under investigation, is attributed to the influence of the dark current on the photogeneration process and will be discussed elsewhere. As expected, the generation-recombination term, S_{GR} , is the main contribution to the QWIP noise. At low temperatures ($T_{QWIP} \leq 10$ K), the detector performance is limited by the background-induced photocurrent noise, with the thermal and dark current noise representing a negligible contribution. Above T_{BLIP} , the QWIP device is dominated by dark current noise. The estimated total current noise based on the photoconductor model (continuous green line) accurately reproduces the noise measurements as a function of temperature within experimental error.

Figure 3 presents the photoconductive gain of our THz QWIP devices as a function of voltage at $T_{OWIP} = 4$ K. The continuous line is the gain obtained from the responsivity calibration of Ref. 8: the triangular symbols correspond to the gain computed from the noise measurements of the 7 μ m array device [Fig. 2(a)]; the square symbols refer to the 9 μ m array device [open square symbols in Fig. 2(b) and full square symbols in Fig. S1(b) in the supplementary material]; the circular symbols refer to the mesa device [Fig. S1(a)]. All noise measurements for this investigation are taken at 10 kHz (except for the dark noise of the 9 μ m detector, which was measured at 1 kHz). The validity and consistency of the H.C. Liu model for noise currents in THz QWIPs is apparent to the data shown in Fig. 3, where the same gain values are obtained by interpreting two totally different measurements: responsivity⁸ and PSD noise. The dashed line shows the capture probability $p_c = 1/gN_{QW}$, where $N_{QW} = 20$ is the number of quantum wells of the THz QWIP under study. Interestingly, we can observe that over a large bias voltage range (25 meV < V < 100 meV), $p_c <$ 0.2, which confirms the assumption that the noise in THz QWIPs can be treated in the same way as in classical photoconductors.² The linear increase in the photoconductive gain is typical for bound-toquasi-continuum QWIPs² because the electron emission from the well is optimized and the drift velocity grows linearly under the relatively low electric field (0-0.6 kV/cm). An estimation of the drift velocity from our data is, however, unfeasible because of the uncertainty in the capture time for THz ISB detectors (Ref. 2). However, the high frequency response recently measured with THz QWIPs, of up to 6 GHz,^{9,10} suggests lifetimes of the order of a few ps (similar to mid-infrared QWIPs^{2,21}) and confirms previous results obtained with a THz two-photon QWIP.¹¹

After analyzing the current noise PSD and the photoconductive gain, it is possible to quantify the photodetector sensitivity in both the mesa and patch antenna geometries. Figure 4(a) shows the noise-equivalent-power (NEP) obtained from noise current measurements by using NEP = i_n/\mathcal{R} , where \mathcal{R} is the measured responsivity for the mesa and for the 7 μ m cavity array devices. For the 9 μ m array device, the responsivity has been calculated by knowing the gain and the absorption coefficient.⁸ The open dots refer to the measured noise current values, whilst the continuous lines correspond to the estimates of NEP = $(4egI_{bg})^{0.5}/\mathcal{R}$ using the measured dc background current for each device. We observe an NEP of ~0.14–0.22 pW/Hz^{0.5} for the 7 μ m patch antenna array, which is five times smaller than that for the mesa device with NEP ~0.6–1.3 pW/Hz^{0.5}. This significant reduction is a result of



FIG. 4. (a) NEP values of the THz QWIPs, both measured (open dots) and estimated from the IV characteristics (continuous line). The inset shows the respective responsivity spectra. Reprinted with permission from Appl. Phys. Lett. **106**(16), 161102 (2015), Copyright AIP Publishing. (b) Frequency dependence of the responsivities for the detector devices under study; the pink curve refers to a $7 \mu m$ antenna-coupled QWIP with a strongly reduced number of patches, i.e., a 3×3 array.

the strongly improved photon absorption in the antenna coupled detectors, which for the 7 μ m array device has an estimated absorption, $\eta_{array} = 37\%$, whilst for the mesa, we quantify $\eta_{\text{mesa}} = 5\%$.⁸ The 9 μ m array device shows a higher NEP of ~3–6 pW/Hz^{0.5} (corresponding to $\eta_{\text{array}} = 13\%$), which is due to the fact that the resonant modes TM_{100} and TM₀₁₀ of these microcavities are largely detuned from the ISB transition [as shown in the responsivity spectra, reproduced on the same scale in the right insets of Fig. 4(a)]. Indeed, the absorption coefficient of the patch-cavity photodetector is directly proportional to the overlap factor between the optical mode and the resonant absorption of the two-level OW.^{8,19} It is, therefore, essential to tailor the parameters of the photonic architecture in order to optimize device performances: the antenna size s has to match the cavity, whilst the electronic resonances and the array spacing p maximize the fraction of photons coupled into the QWIP active region.^{20,21} Using the measured NEP values, it is possible to calculate the background-limited specific detectivity, which is defined as $D_{BL}^* = (A_{det})^{0.5}$ /NEP. We obtain $D_{BL}^* = (1.4-2.3) \times 10^{11}$ cm Hz^{0.5}/W for the 7 μ m array device, $D_{BL}^* = (0.6-1.4)$ $\times 10^{10}$ cm Hz^{0.5}/W for the 9 μ m array device, and D*_{BL} = $(2.3-5.0) \times 10^{10}$ cm Hz^{0.5}/W for the mesa device, using the respective photodetector areas $A_{det} = 9.5 \times 10^4 \,\mu\text{m}^2$ (7 μm cavity array), $A_{det} = 9.2 \times 10^4 \,\mu\text{m}^2$ (9 μ m cavity array), and $A_{det} = 1.1 \times 10^5 \,\mu m^2$ (mesa). The detectivity values obtained from our measurement confirm the estimates that we reported previously.8

Recently, optical heterodyne detection has been demonstrated as a tool to enhance quantum well photodetector performance:²¹ this technique involves the coherent beating of a high power local-oscillator (LO) with a weak signal source on a fast detector. Employing a THz QCL as an LO^{16,32} with an output power of ~ 1 mW and a weak THz source as the signal, it is possible to demonstrate^{2,21} that the heterodyne NEP scales down to NEP_{het} $\sim 4eg/\mathcal{R} = 0.1$ aW/Hz^{0.5}, which is several orders of magnitude lower than that we obtain in dc, 0.2 pW/Hz^{0.5}. This ultra-high sensitivity device, comparable to THz photon counters based on nano-bolometers,³³ could be used, for example, to probe early universe THz radiation³⁴ or to assess the mutual coherence in THz laser frequency combs.³⁵ Moreover, a quantum well photodetector in an optical heterodyne system is highly convenient owing to its high frequency response.^{2,21} Figure 4(b) shows the responsivity of the THz QWIP under study as a function of modulation frequency.^{36,37} For the 400 μ m mesa, 9 μ m cavity array, and 7 μ m cavity array devices, we find C_{mesa} = 19.1 pF, C_{9 μ m} = 4.7 pF, and C_{7 μ m} = 4.3 pF, respectively, corresponding to cut-off frequencies f_{mesa} = 167 MHz, $f_{9\mu m}$ = 682 MHz, and $f_{7\mu m}$ = 748 MHz. Reducing the number of patches down to a 3 × 3 microcavity array could give a capacitance of C_{3×3} = 52.6 fF and a cut-off frequency of $f_c \sim 60$ GHz, whilst a single microcavity could analogously give C_{1×1} = 5.5 fF and a cut-off frequency $f_c > 100$ GHz. These devices are therefore extremely promising candidates as high speed and large bandwidth receivers for THz wireless communications.¹³

In summary, we have reported the noise measurements for THz QWIPs including a comparative study between standard mesa and patch-antenna architectures. The noise current spectral density measurements have confirmed the performance calibration of THz QWIPs in terms of responsivity. The microcavity geometry shows NEP values of the order of 0.2 pW/Hz^{0.5}. Future work will focus on investigating THz QWIPs in ultra-subwavelength resonators with strongly reduced current noise²⁰ and photovoltaic quantum cascade detectors³⁸ (operating at ~0 V), which should further improve the performance of THz detectors.

See supplementary material for the description of the noise contributions in the electronic arrangement shown in Fig. 1, the PSD noise measurements of the mesa device (under background exposure) and the 9 μ m array (under dark), and the details of the noise measurements as a function of the temperature of the 7 μ m cavity shown in Fig. 2.

We acknowledge financial support from the FP7 ITN NOTEDEV project (Grant No. 607521), the ERC grant ADEQUATE, the French National Research Agency (No. ANR-16-CE24-0020 Project "hoUDINi"), and the UK EPSRC Programme Grant 'HyperTerahertz' (No. EP/P021859/1). E.H.L. acknowledges support of the Royal Society and the Wolfson Foundation. We are grateful to Dr Li Chen for help in wafer bonding of the sample.

¹B. F. Levine, K. K. Choi, C. G. Bethea, J. Walker, and R. J. Malik, Appl. Phys. Lett. **50**, 1092 (1987).

²H. Schneider and H. C. Liu, in *Quantum Well Infrared Photodetectors: Physics and Applications* (Springer, 2007).

³E. Rosencher and B. Vinter, *Optoelectronics* (Cambridge University Press, 2004).

⁴H. Luo, H. C. Liu, C. Y. Song, and Z. R. Wasilewski, Appl. Phys. Lett. **86**, 231103 (2005).

- ⁵M. Patrashin and I. Hosako, Opt. Lett. 33, 168 (2008).
- ⁶J. C. Cao and H. C. Liu, Semicond. Semimetals 84, 195 (2011).
- ⁷R. Zhang, Z. L. Fu, L. L. Gu, X. G. Guo, and J. C. Cao, Appl. Phys. Lett. **105**, 231123 (2014).
- ⁸D. Palaferri, Y. Todorov, Y. N. Chen, J. Madeo, A. Vasanelli, L. H. Li, A. G. Davies, E. H. Linfield, and C. Sirtori, Appl. Phys. Lett. **106**(16), 161102 (2015).
- ⁹B. Paulillo, S. Pirotta, H. Nong, P. Crozat, S. Guilet, G. Xu, S. Dhillon, L. H. Li, A. G. Davies, E. H. Linfield, and R. Colombelli, Optica 4(12), 1451–1456 (2017).
- ¹⁰H. Li, W.-J. Wan, Z.-Y. Tan, Z.-L. Fu, H.-X. Wang, T. Zhou, Z.-P. Li, C. Wang, X.-G. Guo, and J.-C. Cao, Sci. Rep. 7, 3452 (2017).
- ¹¹H. Schneider, H. C. Liu, S. Winnerl, C. Y. Song, M. Walther, and M. Helm, Opt. Express **17**(15), 12279–12284 (2009).
- ¹²A. Rogalski and F. Sizov, Opto-Electron. Rev. **19**(3), 353 (2011).
- ¹³T. Nagatsuma, G. Ducournau, and C. C. Renaud, Nat. Photonics 10(6), 371 (2016).
- ¹⁴R. A. Kaindl, M. A. Carnahan, D. Hägele, R. Lövenich, and D. S. Chemla, Nature **423**(6941), 734 (2003).
- ¹⁵Z. Zhou, T. Zhou, S. Zhang, Z. Shi, Y. Chen, W.-J. Wan, X. Li, X. Chen, S. N. G. Corder, Z.-L. Fu, L. Chen, Y. Mao, J.-C. Cao, F. G. Omenetto, M. Liu, H. Li, and T. H. Tao, Adv. Sci. 5(7), 1700982 (2018).
- ¹⁶Y. Yang, D. Burghoff, D. J. Hayton, J. R. Gao, J. L. Reno, and Q. Hu, Optica 3(5), 499–502 (2016).
- ¹⁷S. Barbieri, M. Ravaro, P. Gellie, G. Santarelli, C. Manquest, C. Sirtori, S. P. Khanna, E. H. Linfield, and A. G. Davies, Nat. Photonics 5(5), 306 (2011).
- ¹⁸Y. Todorov, L. Tosetto, J. Teissier, A. Andrews, P. Klang, R. Colombelli, I. Sagnes, G. Strasser, and C. Sirtori, Opt. Express 18, 13886 (2010).
- ¹⁹Y. N. Chen, Y. Todorov, B. Askenazi, A. Vasanelli, G. Biasiol, R. Colombelli, and C. Sirtori, Appl. Phys. Lett. **104**, 031113 (2014).
- ²⁰D. Palaferri, Y. Todorov, A. Mottaghizadeh, G. Frucci, G. Biasiol, and C. Sirtori, New J. Phys. 18, 113016 (2016).
- ²¹D. Palaferri, Y. Todorov, A. Bigioli, A. Mottaghizadeh, D. Gacemi, A. Calabrese, A. Vasanelli, L. Li, A. G. Davies, E. H. Linfield, F. Kapsalidis, M. Beck, J. Faist, and C. Sirtori, *Nature* **556**(7699), 85–88 (2018).

- ²²B. F. Levine, A. Zussmann, S. D. Gunapala, M. T. Asom, J. M. Kuo, and W. S. Hobson, J. Appl. Phys. **72**, 4429 (1992).
- ²³H. C. Liu, Appl. Phys. Lett. **60**, 1507 (1992).
- ²⁴W. A. Beck, Appl. Phys. Lett. **63**, 3589 (1993).
- ²⁵C. Schonbein, H. Schneider, R. Rehm, and M. Walther, Appl. Phys. Lett. 73, 1251 (1998).
- ²⁶R. Rehm, H. Schneider, C. Schoenbein, and M. Walther, Physica E 7, 124–129 (2000).
- ²⁷See https://www.femto.de/en/products/current-amplifiers/ for "Data-sheet FEMTO DLPCA-200," (accessed 20 July 2018).
- ²⁸A. Delga, L. Doyennette, M. Carras, V. Trinité, and P. Bois, Appl. Phys. Lett. **102**, 163507 (2013).
- ²⁹M. Ravaro, P. Gellie, G. Santarelli, C. Manquest, P. Filloux, C. Sirtori, J. F. Lampin, G. Ferrari, S. P. Khanna, E. H. Linfield, H. E. Beere, D. A. Ritchie, and S. Barbieri, IEEE J. Sel. Top. Quantum Electron. **19**(1), 8501011–8501011 (2013).
- ³⁰A. Delga, L. Doyennette, A. Buffaz, V. Berger, F. R. Jasnot, N. Péré-Laperne, L.-A. De Vaulchier, and H. C. Liu, J. Appl. Phys. **110**, 013714 (2011).
- ³¹D. Palaferri, Ph.D. thesis, University of Paris Diderot, Paris, 2018.
- ³²H.-W. Hübers, S. G. Pavlov, A. D. Semenov, R. Köhler, L. Mahler, A. Tredicucci, H. E. Beere, D. A. Ritchie, and E. H. Linfield, Opt. Express 13(15), 5890–5896 (2005).
- ³³J. Wei, D. Olaya, B. S. Karasik, S. V. Pereverzev, A. V. Sergeev, and M. E. Gershenson, Nat. Nanotechnol. 3(8), 496 (2008).
- ³⁴P. H. Siegel, in *Microwave Symposium Digest*, IEEE MTT-S International 816-819 (2010).
- ³⁵D. Burghoff, Y. Yang, D. J. Hayton, J.-R. Gao, J. L. Reno, and Q. Hu, Opt. Express 23(2), 1190 (2015).
- ³⁶R. Saran and R. J. Curry, Nat. Photonics **10**(2), 81–92 (2016).
- ³⁷The frequency dependent responsivity is defined as (see Ref. 36) $\Re(f) = \Re_{dc}/(1 + (2\pi\tau_c f)^2)^{0.5}$ where \Re_{dc} is the dc responsivity and $\tau_c = R_{50\Omega}C_{QWIP}$ is the time response related to the frequency 3dB cut-off of the detector, including the 50 Ω output impedance ($R_{50\Omega}$) and C_{QWIP} , the QWIP electric capacitance.
- ³⁸M. Graf, G. Scalari, D. Hofstetter, J. Faist, H. Beere, E. Linfield, D. Ritchie, and G. Davies, Appl. Phys. Lett. 84, 475 (2004).